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15 MAY 1998

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Norio FUKASAWA et al.**
PCT/JP97/02405

Serial No.: **09/029,608**

PATENT

ATTN: PCT BRANCH

Filed: **March 10, 1998**

**FOR: METHOD AND MOLD FOR MANUFACTURING SEMICONDUCTOR DEVICE,
SEMICONDUCTOR DEVICE, AND METHOD FOR MOUNTING THE DEVICE**

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

May 15, 1998

Sir:

Prior to examination of the above application, please amend the application as follows:

IN THE CLAIMS:

- ✓ Claim 4, lines 2 and 3, delete "any of claims 1 to 3" and substitute therefor --claim 1 or 2--.
- ✓ Claim 5, lines 2 and 3, delete "any of claims 1 to 4" and substitute therefor --claim 1 or 2--.
- ✓ Claim 6, lines 2 and 3, delete "any of claims 1 to 5" and substitute therefor --claim 1 or 2--.
- ✓ Claim 7, lines 2 and 3, delete "any of claims 3 to 6" and substitute therefor --claim 1 or 2--.
- ✓ Claim 9, lines 2 and 3, delete "any of claims 1 through 8" and substitute therefor --claim 1 or 2--.

*7/16
Ampl. A
J. H. K.
9-30-98*